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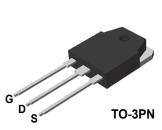
FQA10N80C-F109 N-Channel QFET[®] MOSFET 800 V, 10 A, 1.1 Ω

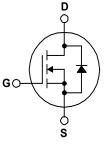
Features

- + 10 A, 800 V, $R_{DS(on)}$ = 1.1 Ω (Max.) @ V_{GS} = 10 V, I_D = 5 A
- Low Gate Charge (Typ. 44 nC)
- Low Crss (Typ. 15 pF)
- 100% Avalanche Tested
- RoHS compliant

Description

This N-Channel enhancement mode power MOSFET is produced using ON Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, active power factor correction (PFC), and electronic lamp ballasts.





MOSFET Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol	Parameter Drain to Source Voltage			FQA10N80C-F109	Unit V
V _{DSS}				800	
1	Drain Current	-Continuous (T _C = 25 ^o C)		10	А
I _D		-Continuous (T _C = 100 ^o C)		6.32	А
I _{DM}	Drain Current	- Pulsed	(Note 1)	40	А
V _{GSS}	Gate to Source Voltage			± 30	V
E _{AS}	Single Pulsed Avalanch	e Energy	(Note 2)	920	mJ
I _{AR}	Avalanche Current		(Note 1)	10	А
E _{AR}	Repetitive Avalanche Er	nergy	(Note 1)	24	mJ
dv/dt	Peak Diode Recovery dv/dt		(Note 3)	4.0	V/ns
P _D	Power Dissipation	(T _C = 25°C)		240	W
		- Derate above 25 ^o C		1.92	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range			-55 to +150	°C
Τ _L	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds			300	°C

Thermal Characteristics

Symbol	Parameter	FQA10N80C-F109	Unit	
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction to Case, Max	0.52	°C/W	
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction to Ambient, Max	40	°C/W	

Part NumberTop MarkFQA10N80C-F109FQA10N80C		Top Mark	Package	Packing Method	Reel Siz	e .	Tape Widt	h Q	Quantity	
		TO-3PN Tube N/A		N/A		3	30 units			
Electric	cal Char	acteristics $T_{\rm C} = 25^{\circ}$	C unless oth	nerwise noted.						
Symbol	Parameter		Test Conditions		Min	Тур	Мах	Unit		
	racteristi	cs							-	
BV _{DSS}	Drain-Sour	rce Breakdown Voltage	V _{GS} = 0 V, I _D = 250 μA			800			V	
ΔBV _{DSS} / ΔT _J	Breakdowr Coefficient	n Voltage Temperature	I_D = 250 µA, Referenced to 25°C			0.98		V/°C		
1	Zoro Coto	Zana Oata Maltana Duain Oursent		V _{DS} = 800 V, V _{GS} = 0 V				10	μA	
IDSS	Zero Gate Voltage Drain Current		V _{DS} = 640 V, T _C = 125°C				100	μA		
I _{GSSF}	Gate-Body	Leakage Current, Forward	V _{GS} = 30 V, V _{DS} = 0 V				100	nA		
I _{GSSR}	Gate-Body	Leakage Current, Reverse	V _{GS} = -3	0 V, V _{DS} = 0 V				-100	nA	
	racteristi	cs							-	
V _{GS(th)}		shold Voltage	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$		3.0		5.0	V		
R _{DS(on)}	Static Drain On-Resista		00	V_{GS} = 10 V, I _D = 5.0 A			0.93	1.1	Ω	
9 _{FS}	Forward Tr	ransconductance	V _{DS} = 50	V, I _D = 5.0 A			5.8		S	
Dynami	c Charac	teristics								
C _{iss}	Input Capa	icitance	V _{DS} = 25	V _{DS} = 25 V, V _{GS} = 0 V, f = 1.0 MHz			2150	2800	pF	
C _{oss}	Output Ca	pacitance	f = 1.0 M				180	230	pF	
C _{rss}	Reverse T	ransfer Capacitance					15	20	pF	
Switchi	ng Chara	cteristics								
t _{d(on)}	Turn-On D	elay Time	Vpp = 40	V _{DD} = 400 V, I _D = 10.0 A,			50	110	ns	
t _r	Turn-On R	ise Time	R _G = 25				130	270	ns	
t _{d(off)}	Turn-Off D	elay Time	Ĩ				90	190	ns	
t _f	Turn-Off Fa	all Time			(Note4)		80	170	ns	
Qg	Total Gate	Charge	V _{DS} = 64	V _{DS} = 640 V, I _D = 10.0 A,		-	45	58	nC	
Q _{gs}	Gate-Sour	ce Charge	V _{GS} = 10 V		-	13.5		nC		
Q _{gd}	Gate-Drain	1 Charge			(Note 4)		17		nC	
Drain-S	ource Dic	ode Characteristics a	nd Maxir	num Ratings						
ls	Maximum Continuous Drain-Source Diode Forward Current						10.0	Α		
3			Forward Current							

V

ns

μC

1.4

--

730

10.9

Q_{rr} Notes :

 V_{SD}

t_{rr}

1. Repetitive Rating : Pulse width limited by maximum junction temperature.

Drain-Source Diode Forward Voltage

2. L = 17.3 mH, I_{AS} = 10 A, V_{DD} = 50 V, R_G = 25 $\Omega,$ starting $\mbox{ T}_{J}$ = 25°C.

3. I_{SD} \leq 8.4 A, di/dt \leq 200 A/µs, V_{DD} \leq BV_{DSS,} starting ~T_J = 25°C.

Reverse Recovery Time

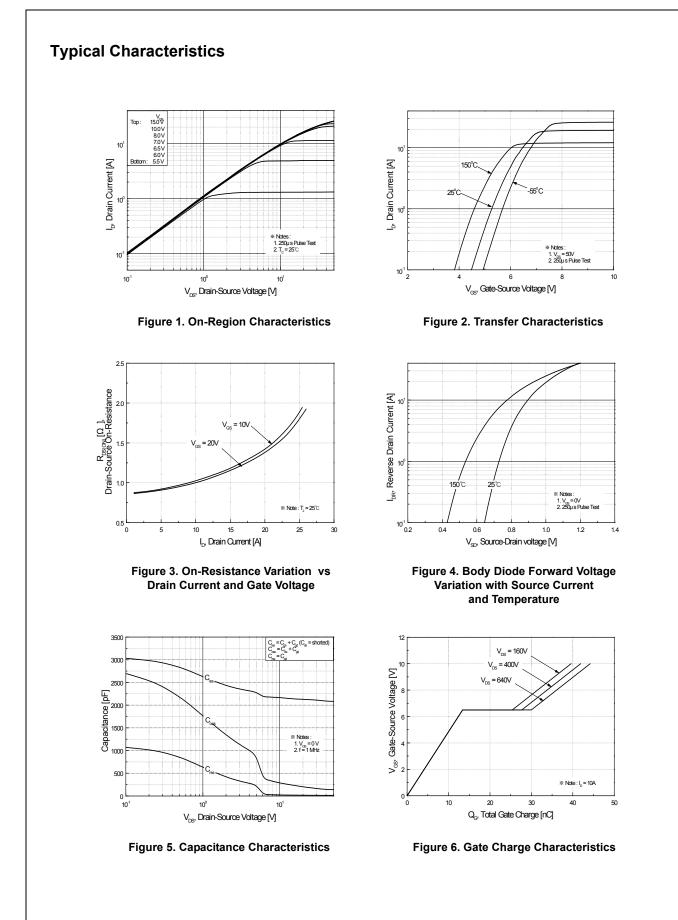
Reverse Recovery Charge

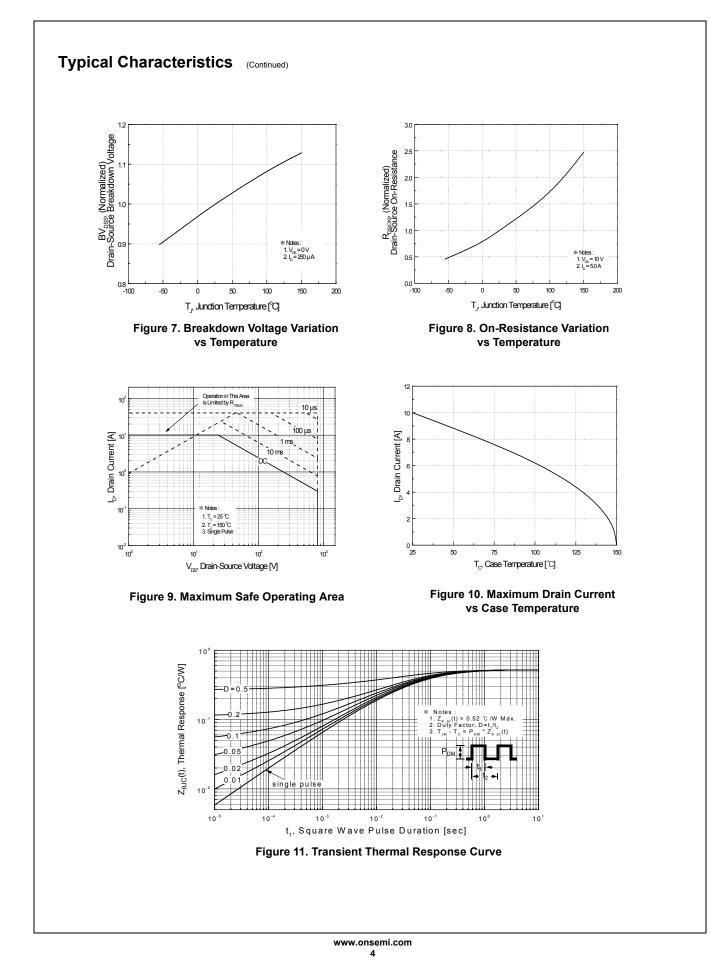
4. Essentially independent of operating temperature.

 V_{GS} = 0 V, I_{S} = 10.0 A

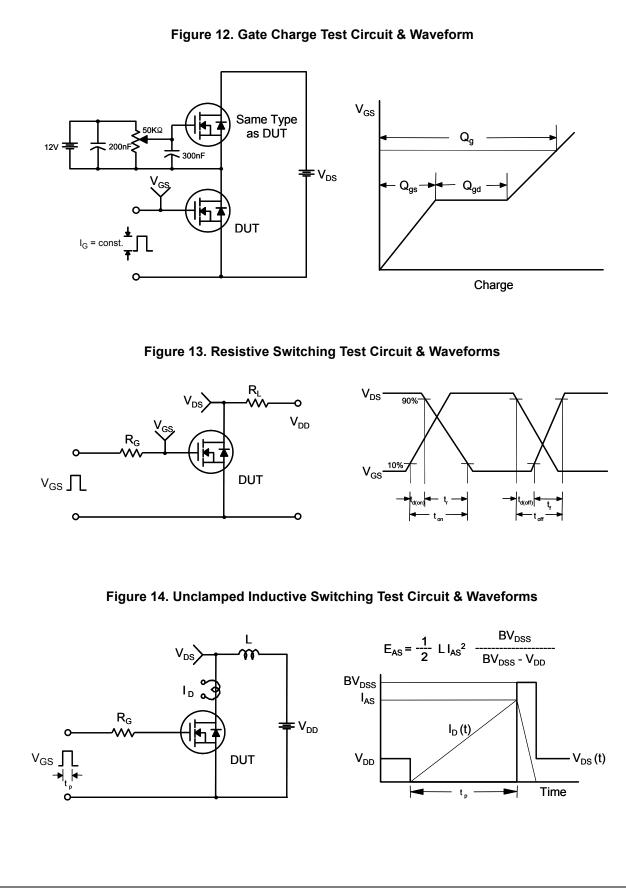
 $V_{GS} = 0 V, I_{S} = 10.0 A,$

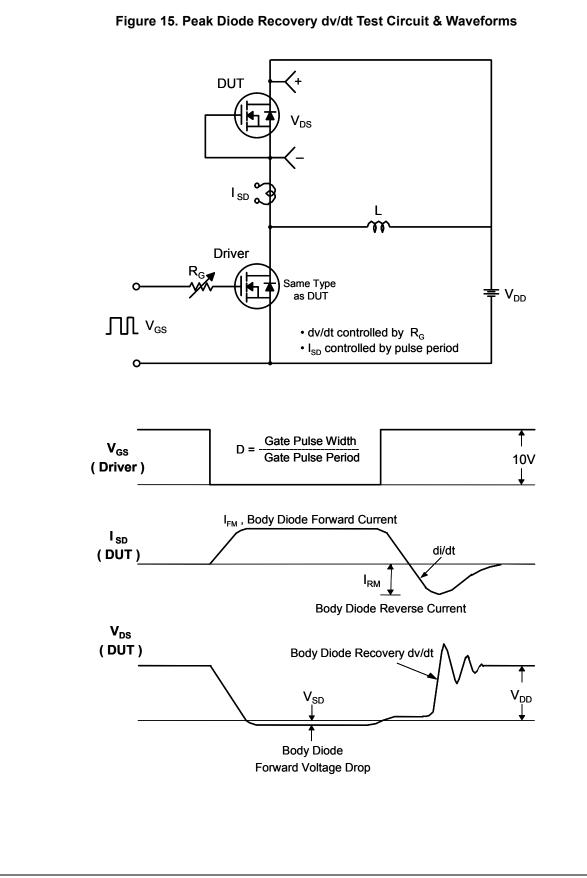
 $dI_F / dt = 100 \text{ A/}\mu\text{s}$

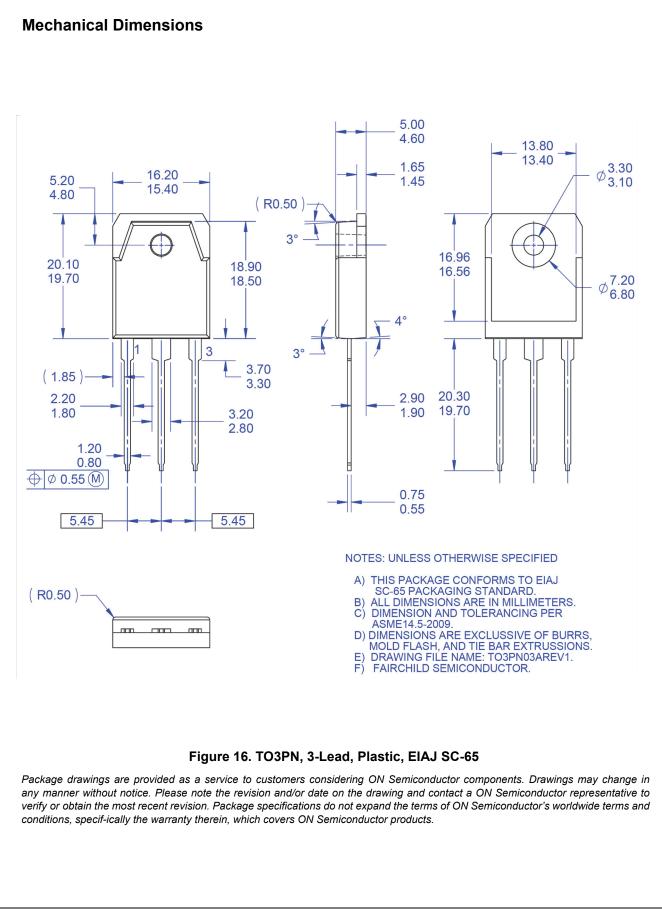




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